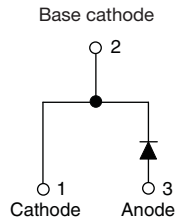


Hyperfast Rectifier, 30 A FRED Pt®


2L TO-220AC


FEATURES

- Hyper fast and soft recovery time
- Low forward voltage drop
- 175 °C maximum operating junction temperature
- Low leakage current
- True 2 pin package
- AEC-Q101 qualified
- Material categorization:
for definitions of compliance please see www.vishay.com/doc?99912



| PRIMARY CHARACTERISTICS | |
|--------------------------|-------------|
| $I_{F(AV)}$ | 30 A |
| V_R | 650 V |
| V_F at I_F at 125 °C | 1.6 V |
| t_{rr} | 27 ns |
| T_J max. | 175 °C |
| Package | 2L TO-220AC |
| Circuit configuration | Single |

DESCRIPTION / APPLICATIONS

Ultra low V_F , soft-switching hyper fast rectifiers optimized for discontinuous (critical) mode (DCM) power factor correction (PFC).

The minimized conduction loss, optimized stored charge and low recovery current minimized the switching losses and reduce over dissipation in the switching element and snubbers.

The device is also intended for use as a freewheeling diode in power supplies and other power switching applications.

| ABSOLUTE MAXIMUM RATINGS | | | | |
|--|----------------|-----------------------|-------------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
| Repetitive peak reverse voltage | V_{RRM} | | 650 | V |
| Average rectified forward current | $I_{F(AV)}$ | $T_C = 120\text{ °C}$ | 30 | A |
| Non-repetitive peak surge current | I_{FSM} | $T_C = 25\text{ °C}$ | 210 | |
| Operating junction and storage temperature | T_J, T_{Stg} | | -55 to +175 | °C |

| ELECTRICAL SPECIFICATIONS ($T_J = 25\text{ °C}$ unless otherwise specified) | | | | | | |
|--|---------------|--|------|------|------|---------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Breakdown voltage, blocking voltage | V_{BR}, V_R | $I_R = 250\text{ }\mu\text{A}$ | 650 | - | - | V |
| Forward voltage | V_F | $I_F = 30\text{ A}$ | - | 2.1 | 2.5 | |
| | | $I_F = 30\text{ A}, T_J = 125\text{ °C}$ | - | 1.6 | 1.7 | |
| Reverse leakage current | I_R | $V_R = V_R$ rated | - | 0.02 | 30 | μA |
| | | $T_J = 150\text{ °C}, V_R = V_R$ rated | - | 50 | 300 | |
| Junction capacitance | C_T | $V_R = 200\text{ V}$ | - | 22 | - | pF |
| Series inductance | L_S | Measured lead to lead 5 mm from package body | - | 8.0 | - | nH |



| DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified) | | | | | | | |
|--|------------------|-------------------------|--|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNITS |
| Reverse recovery time | t _{rr} | T _J = 25 °C | I _F = 1 A dI _F /dt = 100 A/μs V _R = 30 V | - | 35 | - | ns |
| | | T _J = 25 °C | | - | 27 | - | |
| | | T _J = 125 °C | | - | 88 | - | |
| Peak recovery current | I _{RRM} | T _J = 25 °C | I _F = 30 A dI _F /dt = 1000 A/μs V _R = 400 V | - | 15 | - | A |
| | | T _J = 125 °C | | - | 24 | - | |
| Reverse recovery charge | Q _{rr} | T _J = 25 °C | | - | 330 | - | nC |
| | | T _J = 125 °C | | - | 1350 | - | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | | |
|--|-----------------------------------|---|--|--------------|------|------------|------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNITS |
| Thermal resistance, junction to case | R _{thJC} | | | - | 1.0 | 1.3 | °C/W |
| Thermal resistance, junction to ambient | R _{thJA} | Typical socket mount | | - | - | 70 | |
| Thermal resistance, case to heat sink | R _{thCS} | Mounting surface, flat, smooth, and greased | | - | - | 0.5 | |
| Weight | | | | - | 0.2 | - | g |
| | | | | - | 0.07 | - | oz. |
| Mounting torque | | | | 6.0 (5.0) | - | 12 (10) | kgf · cm (lbf · in) |
| Maximum junction and storage temperature range | T _J , T _{Stg} | | | -55 | - | 175 | °C |
| Marking device | | Case style: 2L TO-220AC | | ETX3007TH | | | |

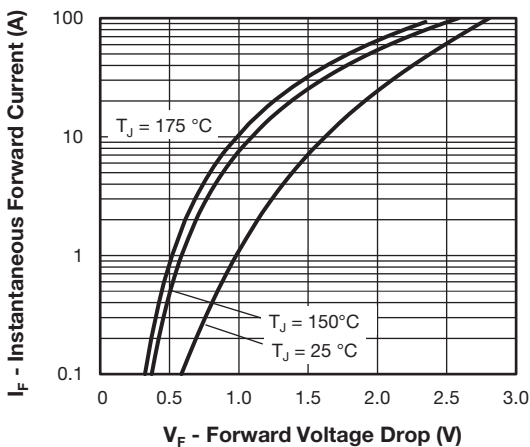


Fig. 1 - Typical Forward Voltage Drop Characteristics

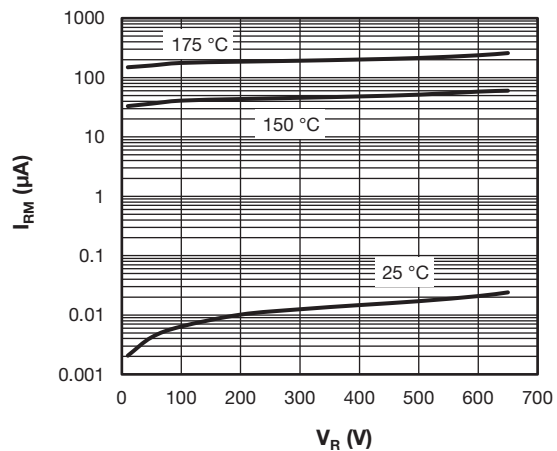


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

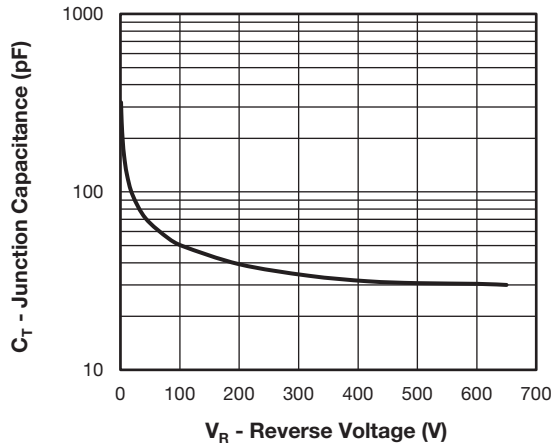


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

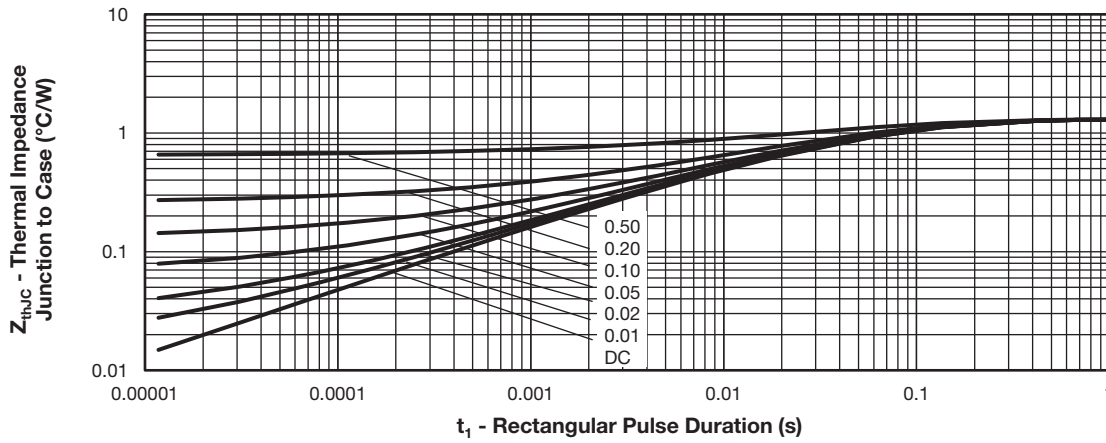


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

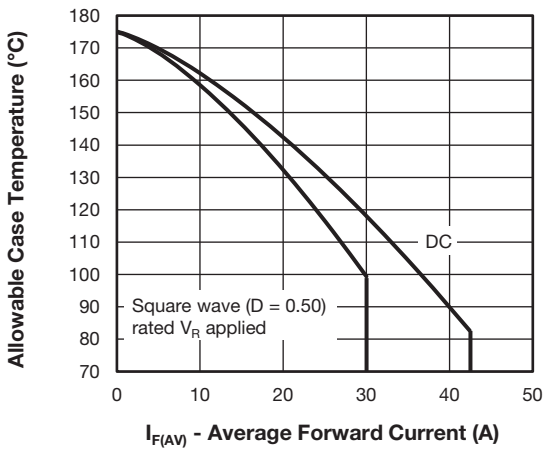


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

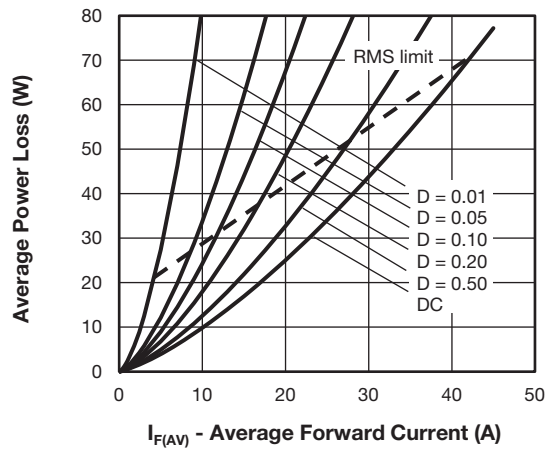
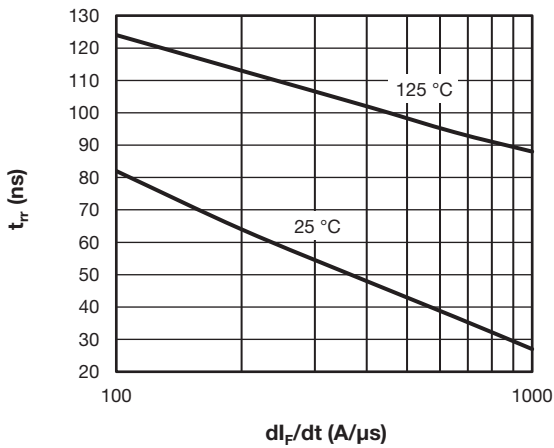
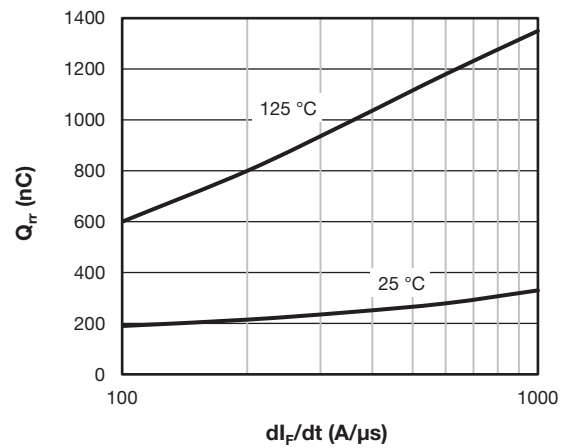
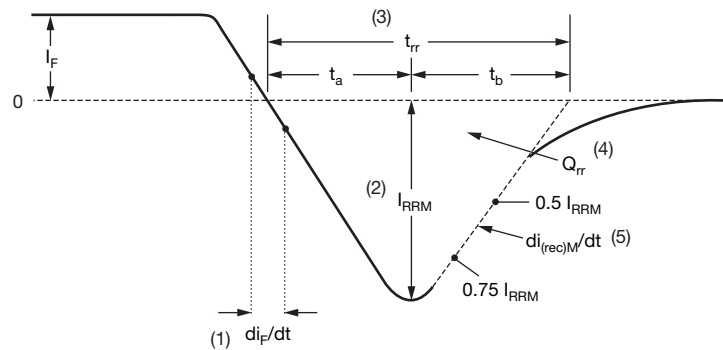


Fig. 6 - Forward Power Loss Characteristics


 Fig. 7 - Typical Reverse Recovery Time vs. di_F/dt

 Fig. 8 - Typical Reverse Recovery Time vs. di_F/dt


- (1) di_F/dt - rate of change of current through zero crossing
- (2) I_{RRM} - peak reverse recovery current
- (3) t_{rr} - reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through $0.75 I_{RRM}$ and $0.50 I_{RRM}$ extrapolated to zero current.

- (4) Q_{rr} - area under curve defined by t_{rr} and I_{RRM}

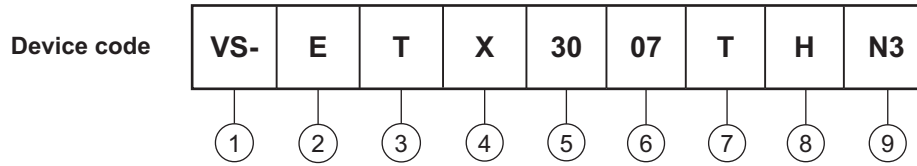
$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

- (5) $di_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

Fig. 9 - Reverse Recovery Waveform and Definitions



ORDERING INFORMATION TABLE



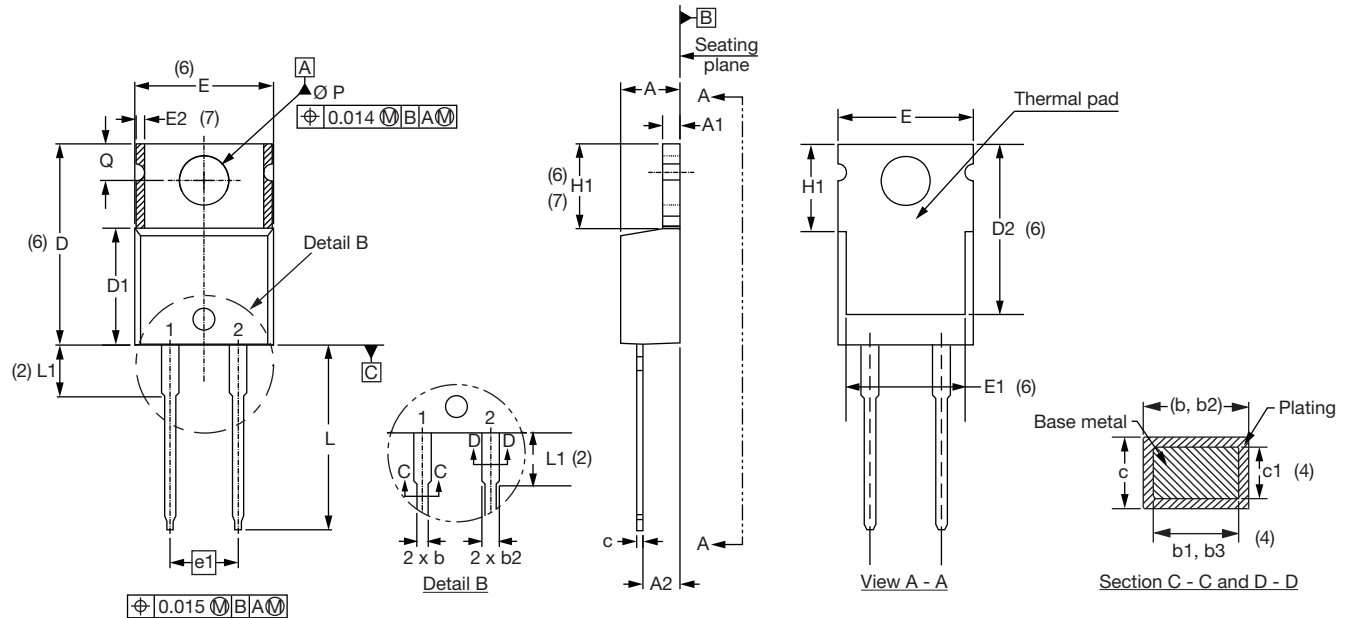
- 1** - Vishay Semiconductors product
- 2** - E = single diode
- 3** - Package:
T = TO-220
- 4** - X = hyper fast recovery
- 5** - Current rating (30 = 30 A)
- 6** - Voltage rating (07 = 650 V)
- 7** - T = True 2 pin TO-220
- 8** - H = AEC-Q101 qualified
- 9** - Environmental digit:
N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

| ORDERING INFORMATION (Example) | | | |
|--------------------------------|-------------------|------------------------|-------------------------|
| PREFERRED P/N | QUANTITY PER TUBE | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION |
| VS-ETX3007THN3 | 50 | 1000 | Antistatic plastic tube |

| LINKS TO RELATED DOCUMENTS | |
|----------------------------|--|
| Dimensions | www.vishay.com/doc?96069 |
| Part marking information | www.vishay.com/doc?95391 |
| SPICE model | www.vishay.com/doc?96532 |

2L TO-220AC

DIMENSIONS in millimeters and inches



| SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|-------|--------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | |
| A | 4.25 | 4.65 | 0.167 | 0.183 | |
| A1 | 1.14 | 1.40 | 0.045 | 0.055 | |
| A2 | 2.56 | 2.92 | 0.101 | 0.115 | |
| b | 0.69 | 1.01 | 0.027 | 0.040 | |
| b1 | 0.38 | 0.97 | 0.015 | 0.038 | 4 |
| b2 | 1.20 | 1.73 | 0.047 | 0.068 | |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 | 4 |
| c | 0.36 | 0.61 | 0.014 | 0.024 | |
| c1 | 0.36 | 0.56 | 0.014 | 0.022 | 4 |
| D | 14.85 | 15.25 | 0.585 | 0.600 | 3 |
| D1 | 8.38 | 9.02 | 0.330 | 0.355 | |
| D2 | 11.68 | 12.88 | 0.460 | 0.507 | 6 |
| E | 10.11 | 10.51 | 0.398 | 0.414 | 3, 6 |

| SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|-------|--------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | |
| E1 | 6.86 | 8.89 | 0.270 | 0.350 | 6 |
| E2 | - | 0.76 | - | 0.030 | 7 |
| e1 | 4.88 | 5.28 | 0.192 | 0.208 | |
| H1 | 5.84 | 6.86 | 0.230 | 0.270 | 6, 7 |
| L | 13.52 | 14.02 | 0.532 | 0.552 | |
| L1 | 3.32 | 3.82 | 0.131 | 0.150 | 2 |
| Ø P | 3.54 | 3.73 | 0.139 | 0.147 | |
| Q | 2.60 | 3.00 | 0.102 | 0.118 | |

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimension E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC® TO-220, except D2, where JEDEC® minimum is 0.480"



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